## intersil

Data Sheet

#### November 2002

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FN8038.2
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## QFN Packaged, ±15kV ESD Protected, +2.7V to +5.5V, 10Nanoamp, 250kbps/ 1Mbps, RS-232 Transceivers with Enhanced Automatic Powerdown

The Intersil ISL4238E/44E/45E devices are 2.7V to 5.5V powered RS-232 transmitters/receivers which meet EIA/TIA-232 and V.28/V.24 specifications, even at  $V_{CC}$  = 3.0V. Additionally, they provide ±15kV ESD protection (IEC6100-4-2 Air Gap and Human Body Model) on transmitter outputs and receiver inputs (RS-232 pins). Targeted applications are PDAs, Palmtops, and notebook and laptop computers where the low operational, and even lower standby, power consumption is critical. Efficient onchip charge pumps, coupled with manual and enhanced automatic powerdown functions, reduce the standby supply current to a 10nA trickle. Tiny 5mm x 5mm Quad Flat No-Lead (QFN) packaging and the use of small, low value capacitors ensure board space savings as well. Data rates greater than 250kbps (ISL4238E/44E) / 1Mbps (ISL4245E) are guaranteed at worst case load conditions.

The ISL424XE are 3 driver, 5 receiver (DTE) devices that, coupled with the QFN package, provide the industry's smallest, lowest power complete serial port suitable for PDAs, and laptop or notebook computers. The 5x5 QFN requires 60% less board area than a 28 lead TSSOP, and is nearly 20% thinner. The devices also include a noninverting always-active receiver for "wake-up" capability.

The ISL4238E is a 5 driver, 3 receiver device optimized for DCE applications with full hardware handshaking. It also includes a noninverting always-active receiver for RING INDICATOR monitoring. Transmitter and logic inputs include active feedback resistors that retain the input state once driven to a valid logic level.

## These devices feature an enhanced automatic

*powerdown* function which powers down the on-chip powersupply and driver circuits. This occurs when all receiver and transmitter inputs detect no signal transitions for a period of 30sec. These devices power back up, automatically, whenever they sense a transition on any transmitter or receiver input.

Table 1 summarizes the features of the ISL4238E/4XE, while Application Note AN9863 summarizes the features of each device comprising the 3V RS-232 family.

## Features

- Parameters Fully Specified for 10% Tolerance Supplies and Full Industrial Temp Range
- Available in Small QFN (5mm x 5mm) Package which is 60% Smaller than a 28 Lead TSSOP
- ESD Protection for RS-232 I/O Pins to ±15kV (IEC6100)
- DTE (ISL4244E/45E) and DCE (ISL4238E) Versions
- Active Feedback Resistors on  $\mathsf{T}_X$  and Logic Inputs (ISL4238E)
- Flow Through Pinouts
- Manual and Enhanced Automatic Powerdown Features
- Guaranteed Minimum Data Rate 250kbps (ISL4238E/44E) / 1Mbps (ISL4245E)
- Latch-Up Free
- On-Chip Charge Pumps Require Only Four External 0.1µF Capacitors
- Wide Power Supply Range ..... Single +2.7V to +5.5V
- Meets EIA/TIA-232 and V.28/V.24 Specifications at 3V
- RS-232 Compatible with V<sub>CC</sub> = 2.7V

## Applications

- Any Space Constrained System Requiring RS-232 Ports
  - Battery Powered, Hand-Held, and Portable Equipment
  - Laptop Computers, Notebooks
  - PDAs and Palmtops, Data Cables
  - Cellular/Mobile Phones, Digital Cameras, GPS Receivers

## **Related Literature**

- Technical Brief TB363 "Guidelines for Handling and Processing Moisture Sensitive Surface Mount Devices"
- Technical Brief TB379 "Thermal Characterization of Packages for ICs"
- Technical Brief TB389 "PCB Land Pattern Design and Surface Mount Guidelines for QFN Packages"

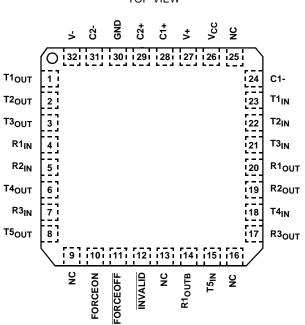
PART NUMBER	NO. OF Tx.	NO.OF Rx.	CONFIG.	QFN PKG.	NO. OF MONITOR Rx. (R <sub>OUTB</sub> )	DATA RATE (kbps)	Rx. ENABLE FUNCTION?	MANUAL POWER- DOWN?	ENHANCED AUTOMATIC POWERDOWN FUNCTION?
ISL4238E	5	3	DCE	5x5	1	250	NO	YES	YES
ISL4244E	3	5	DTE	5x5	1	250	NO	YES	YES
ISL4245E	3	5	DTE	5x5	1	1000	NO	YES	YES

#### TABLE 1. SUMMARY OF FEATURES

## **Ordering Information**

PART NO. (BRAND)	TEMP. RANGE ( <sup>O</sup> C)	PACKAGE	PKG. NO.
ISL4238EIR (4238EIR)	-40 to 85	32 Ld QFN	L32.5x5
ISL4238EIR-T (4238EIR)	-40 to 85	Tape & Reel	L32.5x5
ISL4244EIR (4244EIR)	-40 to 85	32 Ld QFN	L32.5x5

## **Pinouts**



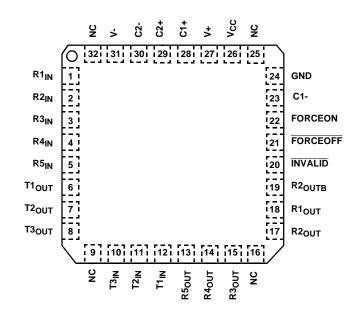
ISL4238E (QFN)



## **Ordering Information** (Continued)

PART NO. (BRAND)	TEMP. RANGE ( <sup>O</sup> C)	PACKAGE	PKG. NO.
ISL4244EIR-T (4244EIR)	-40 to 85	Tape & Reel	L32.5x5
ISL4245EIR (4245EIR)	-40 to 85	32 Ld QFN	L32.5x5
ISL4245EIR-T (4245EIR)	-40 to 85	Tape & Reel	L32.5x5



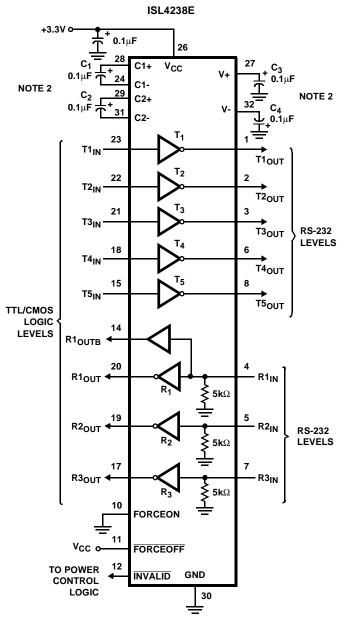


## **Pin Descriptions**

PIN	FUNCTION
V <sub>CC</sub>	System power supply input (2.7V to 5.5V).
V+	Internally generated positive transmitter supply (+5.5V).
V-	Internally generated negative transmitter supply (-5.5V).
GND	Ground connection.
C1+	External capacitor (voltage doubler) is connected to this lead.
C1-	External capacitor (voltage doubler) is connected to this lead.
C2+	External capacitor (voltage inverter) is connected to this lead.
C2-	External capacitor (voltage inverter) is connected to this lead.
Τ <sub>IN</sub>	TTL/CMOS compatible transmitter Inputs. (Note 1)
T <sub>OUT</sub>	$\pm$ 15kV ESD Protected, RS-232 level (nominally $\pm$ 5.5V) transmitter outputs.
R <sub>IN</sub>	±15kV ESD Protected, RS-232 compatible receiver inputs.
R <sub>OUT</sub>	TTL/CMOS level receiver outputs.
R <sub>OUTB</sub>	TTL/CMOS level, noninverting, always enabled receiver outputs.
INVALID	Active low output that indicates if no valid RS-232 levels are present on any receiver input.
FORCEOFF	Active low to shut down transmitters and on-chip power supply. This overrides any automatic circuitry and FORCEON (see Table 2).
FORCEON	Active high input to override automatic powerdown circuitry thereby keeping transmitters active. (FORCEOFF must be high).
IOTE:	

 ISL4238E input pins incorporate positive feedback resistors. Once the input is driven to a valid logic level, the feedback resistor maintains that logic level until V<sub>CC</sub> is removed. Unused transmitter inputs may be left unconnected by the user.

## **Typical Operating Circuits**

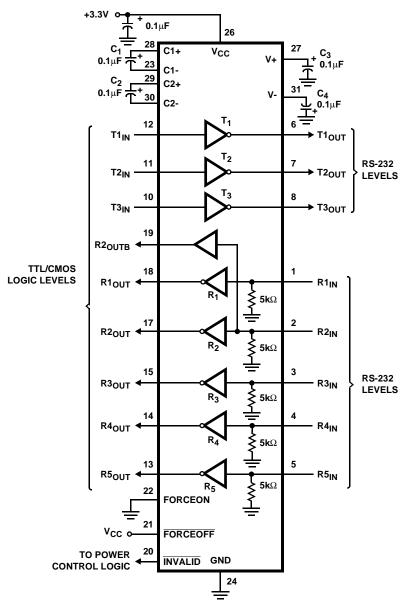


NOTE:

2. For  $V_{CC}$  = 3.15V (3.3V -5%), use  $C_1 - C_4$  = 0.1µF or greater. For  $V_{CC}$  = 3.0V (3.3V -10%), use  $C_1 - C_4$  = 0.22µF or greater.

## Typical Operating Circuits (Continued)

ISL4244E, ISL4245E



#### **Absolute Maximum Ratings**

V <sub>CC</sub> to Ground. -0.3V to 6V   V+ to Ground. -0.3V to 7V   V- to Ground +0.3V to 7V   V+ to V- 14V
Input Voltages
T <sub>IN</sub> , FORCEOFF, FORCEON
R <sub>IN</sub> ±25V
Output Voltages
T <sub>OUT</sub> ±13.2V
R <sub>OUT</sub> , INVALID
Short Circuit Duration
T <sub>OUT</sub> Continuous ESD Rating See Specification Table

#### **Thermal Information**

Thermal Resistance (Typical, Note 3)	$\theta_{JA}$ (°C/W)
32 Ld QFN Package	32
Moisture Sensitivity (see Technical Brief TB363)	
QFN Package	Level 1
Maximum Junction Temperature (Plastic Package)	
Maximum Storage Temperature Range65	<sup>o</sup> C to 150 <sup>o</sup> C
Maximum Lead Temperature (Soldering 10s)	300 <sup>0</sup> C

#### **Operating Conditions**

Temperature Range	
ISL42XXEIR	-40 <sup>o</sup> C to 85 <sup>o</sup> C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

3. θ<sub>JA</sub> is measured in free air with the component mounted on a high effective thermal conductivity test board with "direct attach" features. See Tech Brief TB379, and Tech Brief TB389.

Electrical Specifications	Test Conditions: ISL4238E V <sub>CC</sub> = 3.15V to 5.5V, C <sub>1</sub> - C <sub>4</sub> = ISL424XE V <sub>CC</sub> = 3V to 5.5V, C <sub>1</sub> - C <sub>4</sub> = 0.1 $\mu$ F; Unless Othe					С
PARAMETER	TEST CONDITIONS	TEMP ( <sup>o</sup> C)	MIN	ТҮР	MAX	UNITS
DC CHARACTERISTICS				1		
Operating Voltage Range		Full	2.7	-	5.5	V
Supply Current, Automatic	All R <sub>IN</sub> Open, FORCEON = GND, $\overline{FORCEOFF} = V_{CC}$	25	-	3	300	nA
Powerdown		Full		50	300	nA
Supply Current, Powerdown	All R <sub>IN</sub> Open, FORCEOFF = GND	25	-	3	300	nA
		Full		50	300	nA
Supply Current,	All Outputs Unloaded, FORCEON = $\overline{FORCEOFF} = V_{CC}$ ,	25	-	0.3	1.0	mA
Automatic Powerdown Disabled	$V_{CC} = 3.0V$	Full		0.3	1.5	mA
LOGIC AND TRANSMITTER INP	UTS AND RECEIVER OUTPUTS	1				
Input Logic Threshold Low	T <sub>IN</sub> , FORCEON, FORCEOFF	Full	-	-	0.8	V
Input Logic Threshold High	$T_{IN}$ , FORCEON, FORCEOFF, $V_{CC} = 3.6V$	Full	2.0	-	-	V
Transmitter Input Hysteresis		25	-	0.5	-	V
Input Leakage Current	T <sub>IN</sub> , FORCEON, FORCEOFF (ISL4238E, Note 4)	Full	-	±0.01	±1.0	μΑ
Output Leakage Current	FORCEOFF = GND	Full	-	±0.05	±10	μΑ
Output Voltage Low	I <sub>OUT</sub> = 1.6mA	Full	-	-	0.4	V
Output Voltage High	I <sub>OUT</sub> = -1.0mA	Full	V <sub>CC</sub> -0.6	V <sub>CC</sub> -0.1	-	V
RECEIVER INPUTS		1		1 1		1
Input Voltage Range		Full	-25	-	25	V
Input Threshold Low	V <sub>CC</sub> = 3.0V	Full	-	1.0	0.6	V
Input Threshold High	V <sub>CC</sub> = 3.6V	Full	2.4	1.5	-	V
Input Hysteresis		25	-	0.5	-	V
Input Resistance		Full	3	5	7	kΩ
TRANSMITTER OUTPUTS		1				
Output Voltage Swing	All Transmitter Outputs Loaded with $3k\Omega$ to Ground	Full	±5.0	±5.4	-	V
Output Resistance	$V_{CC} = V + = V - = 0V$ , Transmitter Output = $\pm 2V$	Full	300	10M	-	Ω
Output Short-Circuit Current		Full	-	±35	±60	mA
Output Leakage Current	$V_{OUT} = \pm 12V$ , $V_{CC} = 0V$ or 3V to 5.5V, Automatic Powerdown or FORCEOFF = GND	Full	-	-	±25	μΑ

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## **Electrical Specifications** Test Conditions: ISL4238E $V_{CC} = 3.15V$ to 5.5V, $C_1 - C_4 = 0.1\mu$ F; $V_{CC} = 3V$ , $C_1 - C_4 = 0.22\mu$ F;

00					- · · ·	
ISL424XE $V_{CC}$ = 3V to 5.5V, C <sub>1</sub> - C	$_4 = 0.1 \mu F$ ; Unless	Otherwise	Specified.	Typicals	s are at T <sub>A</sub> = 25 <sup>o</sup> C	;

PARAMETER	TEST CONDITIONS			MIN	ТҮР	МАХ	UNIT
ENHANCED AUTOMATIC POWE	RDOWN (FORCEON = GNI	D, $\overline{\text{FORCEOFF}} = V_{\text{CC}}$ )		· · · · · · · · · · · · · · · · · · ·			
Receiver Input Thresholds to INVALID High	See Figure 6		Full	-2.7	-	2.7	V
Receiver Input Thresholds to INVALID Low	See Figure 6		Full	-0.3	-	0.3	V
INVALID, Output Voltage Low	I <sub>OUT</sub> = 1.6mA		Full	-	-	0.4	V
INVALID, Output Voltage High	I <sub>OUT</sub> = -1.0mA		Full	V <sub>CC</sub> -0.6	-	-	V
Receiver Positive or Negative			25	-	0.5	1	μs
Threshold to INVALID High Delay (t <sub>INVH</sub> )			Full	-	0.9	1.5	μs
Receiver Positive or Negative Threshold to INVALID Low Delay (t <sub>INVL</sub> )	ISL4238E		25 Full	-	60 100	100 150	μs μs
Receiver Positive or Negative	ISL4244E/45E		25	_	30	50	μs
Threshold to INVALID Low Delay (t <sub>INVL</sub> )	10242442/432		Full		40	60	μs
Receiver or Transmitter Edge to Transmitters Enabled Delay (t <sub>WU</sub> )	Note 5		Full	-	20	100	μs
Receiver or Transmitter Edge to Transmitters Disabled Delay (tAUTOPWDN)	Note 5		Full	15	30	60	sec
TIMING CHARACTERISTICS				11		1	
Maximum Data Rate ISL4238E/44E	$R_L = 3k\Omega, C_L = 1000pF, Or$	ne Transmitter Switching	Full	250	500	-	kbps
Maximum Data Rate	$R_L = 3k\Omega$ , One Transmitter Switching	C <sub>L</sub> = 1000pF	Full	250	900	-	kbps
ISL4245E		$V_{CC}$ = 3V to 4.5V, $C_{L}$ = 250pF	Full	1000	2000	-	kbps
		$V_{CC} = 4.5V \text{ to } 5.5V,$ $C_{L} = 1000 \text{pF}$	Full	1000	1500	-	kbps
Receiver Propagation Delay	Receiver Input to Receiver Output, C <sub>L</sub> = 150pF	tphL	25	-	0.15	0.3	μs
			Full	-	0.2	0.35	μs
		<sup>t</sup> PLH	25	-	0.3	0.5	μs
			Full	-	0.35	0.55	μs
Receiver Skew	$t_{PHL} - t_{PLH}, C_L = 150 pF$		25	-	120	250	ns
			Full	-	150	300	ns
Transmitter Propagation Delay	Transmitter Input to	<sup>t</sup> PHL	25	-	0.75	1	μs
ISL4238E/44E	Transmitter Output, $C_L = 1000 \text{pF}, R_L = 3 \text{k}\Omega$		Full	-	0.85	1.1	μs
		t <sub>PLH</sub>	25	-	0.8	1	μs
			Full	-	0.9	1.1	μs
Transmitter Skew ISL4238E/44E	$t_{PHL} - t_{PLH}$ (Note 7), $R_L = 3$	BkΩ, C <sub>L</sub> = 1000pF	25	-	50	200	ns
			Full	-	100	250	ns
Transmitter Propagation Delay ISL4245E	Transmitter Input to	tPHL	25	-	0.4	0.8	μs
	Transmitter Output, C <sub>L</sub> = 1000pF, R <sub>L</sub> = $3k\Omega$		Full	-	0.5	0.8	μs
		t <sub>PLH</sub>	25	-	0.35	0.7	μs
			Full	-	0.4	0.7	μs
Transmitter Skew ISL4245E	$P_{HL}$ - $t_{PLH}$ (Note 6), $R_{L}$ = $3k\Omega$ , $C_{L}$ = 1000pF		25	-	50	200	ns

Electrical Specifications	Test Conditions: ISL4238E V <sub>CC</sub> = 3.15V to 5.5V, C <sub>1</sub> - C <sub>4</sub> = ISL424XE V <sub>CC</sub> = 3V to 5.5V, C <sub>1</sub> - C <sub>4</sub> = 0.1 $\mu$ F; Unless Other					2
PARAMETER	TEST CONDITIONS	TEMP (°C)	MIN	ТҮР	МАХ	UNITS
Receiver Output Enable Time	Normal Operation, $R_L = 1k\Omega$ to 0.5V <sub>CC</sub> , $C_L = 15pF$	25	-	200	350	ns
		Full	-	200	400	ns

Electrical Specifications	Test Conditions: ISL4238E V <sub>CC</sub> = 3.15V to 5.5V, C <sub>1</sub> - C <sub>4</sub> = 0.1 $\mu$ F; V <sub>CC</sub> = 3V, C <sub>1</sub> - C <sub>4</sub> = 0.22 $\mu$ F;
	ISI 424XE V $c_{C}$ = 3V to 5.5V. $C_{4}$ - $C_{4}$ = 0.1µE. Unless Otherwise Specified. Typicals are at T <sub>4</sub> = 25 <sup>o</sup> C

			( - )				
Receiver Output Enable Time	Normal Operation, $R_L = 1k\Omega$ to 0.5V <sub>CC</sub> , $C_L = 15pF$		25	-	200	350	ns
				-	200	400	ns
Receiver Output Disable Time	Normal Operation, $R_L = 1k\Omega$ to 0.5V <sub>CC</sub> , $C_L = 15pF$		25	-	350	500	ns
				-	400	600	ns
Transmitter Output Enable Time	Normal Operation, $R_L = 3k\Omega$ , $C_L = 1000pF$		25	-	25	40	μs
ISL4238E/44E/45E				-	35	50	μs
Transmitter Output Disable Time	Normal Operation, $R_L = 3k\Omega$ , $C_L = 1000pF$		25	-	2.5	4	μs
ISL4238E/44E/45E				-	2.7	4	μs
Transition Region Slew Rate ISL4238E/44E	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 3V \text{ to } 3.6V, \\ R_L = 3k\Omega \text{ to } 7k\Omega, \\ Measured \text{ From } 3V \text{ to } -3V \\ or \ -3V \text{ to } 3V \end{array}$	C <sub>L</sub> = 150pF to 1000pF	25	6	11	30	V/µs
			Full	6	10	30	V/µs
		C <sub>L</sub> = 150pF to 2500pF	25	4	9	30	V/µs
			Full	4	8	30	V/µs
Transition Region Slew Rate	$V_{CC}$ = 3V to 3.6V, $R_L$ = 3k $\Omega$ to 7k $\Omega,$ Measured From 3V to -3V or -3V to 3V, $C_L$ = 150pF to 1000pF		25	24	40	150	V/µs
ISL4245E			Full	24	35	150	V/µs
ESD PERFORMANCE							
RS-232 Pins (T <sub>OUT</sub> , R <sub>IN</sub> )	Human Body Model		25	-	±15	-	kV
	IEC6100-4-2 Air Gap Discharge			-	±15	-	kV
	IEC6100-4-2 Contact Discharge			-	±8	-	kV
All Other Pins	Human Body Model			-	±3	-	kV

NOTES:

4. ISL4238E inputs utilize a positive feedback resistor. The input current is negligible when the input is at either supply rail.

5. An "edge" is defined as a transition through the transmitter or receiver input thresholds.

6. Skew is measured at the receiver input switching points (1.4V).

7. Skew is measured at the transmitter zero crossing points.

## **Detailed Description**

These interface ICs operate from a single +2.7V to +5.5V supply, guarantee a 250kbps (ISL4238E/44E) / 1Mbps (ISL4245E) minimum data rate, require only four small external 0.1µF capacitors, feature low power consumption, and meet all EIA RS-232C and V.28 specifications. The circuit is divided into three sections: The charge pump, the transmitters, and the receivers.

## Charge-Pump

Intersil's new RS-232 family utilizes regulated on-chip dual charge pumps as voltage doublers, and voltage inverters to generate  $\pm 5.5V$  transmitter supplies from a V<sub>CC</sub> supply as low as 3.0V. This allows these devices to maintain RS-232 compliant output levels over the ±10% tolerance range of 3.3V powered systems. The efficient on-chip power supplies require only four small, external 0.1µF capacitors for the voltage doubler and inverter functions. The charge pumps operate discontinuously (i.e., they turn off as soon as the V+ and V- supplies are pumped up to the nominal values), resulting in significant power savings.

#### Transmitters

The transmitters are proprietary, low dropout, inverting drivers that translate TTL/CMOS inputs to EIA/TIA-232 output levels. Coupled with the on-chip ±5.5V supplies, these transmitters deliver true RS-232 levels over a wide range of single supply system voltages.

Transmitter outputs disable and assume a high impedance state when the device enters the powerdown mode (see Table 2). These outputs may be driven to  $\pm 12V$  when disabled.

The ISL4238E/44E guarantee a 250kbps data rate for full load conditions (3k $\Omega$  and 1000pF), V<sub>CC</sub>  $\geq$  3.0V, with one transmitter operating at full speed. Under more typical conditions of  $V_{CC} \ge 3.3V$ ,  $R_L = 3k\Omega$ , and  $C_L = 250pF$ , one transmitter easily operates at 1Mbps.

The ISL4245E guarantees a 1Mbps data rate for full load conditions (3k $\Omega$  and 250pF), V<sub>CC</sub>  $\geq$  3.0V, with one transmitter operating at full speed. Under more typical conditions of  $V_{CC} \ge 3.3V$ ,  $R_L = 3k\Omega$ , and  $C_L = 250pF$ , one transmitter easily operates at 1.4Mbps.

RCVR OR XMTR EDGE WITHIN 30 SEC?	FORCEOFF	FORCEON	TRANSMITTER OUTPUTS	RECEIVER OUTPUTS	R <sub>OUTB</sub> OUTPUTS	RS-232 LEVEL PRESENT AT RECEIVER INPUT?	INVALID OUTPUT	MODE OF OPERATION
NO	Н	Н	Active	Active	Active	NO	L	Normal Operation (Enhanced
NO	Н	Н	Active	Active	Active	YES	Н	Auto Powerdown Disabled)
YES	Н	L	Active	Active	Active	NO	L	Normal Operation (Enhanced
YES	Н	L	Active	Active	Active	YES	Н	Auto Powerdown Enabled)
NO	Н	L	High-Z	Active	Active	NO	L	Powerdown Due to Enhanced
NO	Н	L	High-Z	Active	Active	YES	Н	Auto Powerdown Logic
Х	L	Х	High-Z	High-Z	Active	NO	L	Manual Powerdown
Х	L	Х	High-Z	High-Z	Active	YES	Н	
NVALID DRIVING FORCEON AND FORCEOFF (EMULATES AUTOMATIC POWERDOWN)								
Х	NOTE 8	NOTE 8	Active	Active	Active	YES	Н	Normal Operation
Х	NOTE 8	NOTE 8	High-Z	High-Z	Active	NO	L	Forced Auto Powerdown

#### TABLE 2. POWERDOWN LOGIC TRUTH TABLE

NOTE:

8. Input is connected to INVALID Output.

Transmitter inputs on the ISL424XE float if left unconnected, and may cause  $I_{CC}$  increases. Connect unused inputs to GND for the best performance. ISL4238E transmitter inputs incorporate an active positive feedback resistor that maintains the last input state in the absence of a forcing signal, so unused transmitter inputs may be left unconnected.

#### Receivers

ISL4238E/4XE devices contain standard inverting receivers which can tristate via the FORCEOFF control line. Additionally, they include a noninverting (monitor) receiver (denoted by the R<sub>OUTB</sub> label) that is always active, regardless of the state of any control lines. Both receiver types convert RS-232 signals to CMOS output levels and accept inputs up to ±25V while presenting the required  $3k\Omega$  to  $7k\Omega$  input impedance (see Figure 1) even if the power is off (V<sub>CC</sub> = 0V). The receivers' Schmitt trigger input stage uses hysteresis to increase noise immunity and decrease errors due to slow input signal transitions.

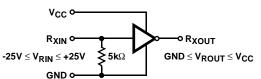


FIGURE 1. INVERTING RECEIVER CONNECTIONS

The ISL4238E/4XE inverting receivers disable during forced (manual) powerdown, but not during automatic powerdown (see Table 2). Conversely, the monitor receiver remains active even during manual powerdown making it extremely useful for Ring Indicator monitoring. Standard receivers driving powered down peripherals must be disabled to

prevent current flow through the peripheral's protection diodes (see Figures 2 and 3). This renders them useless for wake up functions, but the corresponding monitor receiver can be dedicated to this task as shown in Figure 3.

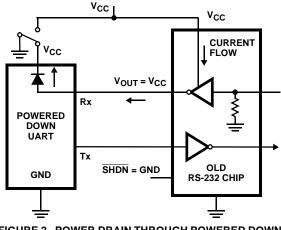
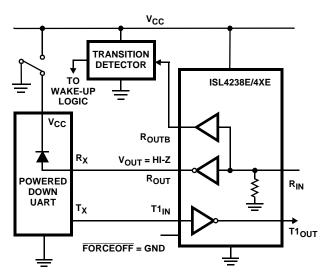


FIGURE 2. POWER DRAIN THROUGH POWERED DOWN PERIPHERAL

## Low Power Operation

These 3V devices require a nominal supply current of 0.3mA, even at  $V_{CC} = 5.5V$ , during normal operation (not in powerdown mode). This is considerably less than the 5mA to 11mA current required by comparable 5V RS-232 devices, allowing users to reduce system power simply by switching to this new family.





## Powerdown Functionality

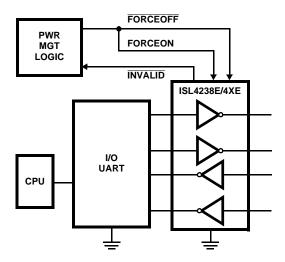
The already low current requirement drops significantly when the device enters powerdown mode. In powerdown, supply current drops to 10nA, because the on-chip charge pump turns off (V+ collapses to  $V_{CC}$ , V- collapses to GND), and the transmitter outputs tristate. Inverting receiver outputs disable only in manual powerdown; refer to Table 2 for details. This micro-power mode makes these devices ideal for battery powered and portable applications.

#### Software Controlled (Manual) Powerdown

These devices allow the user to force the IC into the low power, standby state, and utilize a two pin approach where the FORCEON and FORCEOFF inputs determine the IC's mode. For always enabled operation, FORCEON and FORCEOFF are both strapped high. To switch between active and powerdown modes, under logic or software control, only the FORCEOFF input need be driven. The FORCEON state isn't critical, as FORCEOFF dominates over FORCEON. Nevertheless, if strictly manual control over powerdown is desired, the user must strap FORCEON high to disable the enhanced automatic powerdown circuitry. ISL4238E/4XE inverting (standard) receiver outputs also disable when the device is in manual powerdown, thereby eliminating the possible current path through a shutdown peripheral's input protection diode (see Figures 2 and 3).

Connecting FORCEOFF and FORCEON together disables the enhanced automatic powerdown feature, enabling them to function as a manual SHUTDOWN input (see Figure 4).

With any of the above control schemes, the time required to exit powerdown, and resume transmission is only  $100\mu s$ .



#### FIGURE 4. CONNECTIONS FOR MANUAL POWERDOWN WHEN NO VALID RECEIVER SIGNALS ARE PRESENT

When using both manual and enhanced automatic powerdown (FORCEON = 0), the ISL4238E/4XE won't power up from manual powerdown until both FORCEOFF and FORCEON are driven high, or until a transition occurs on a receiver or transmitter input. Figure 5 illustrates a circuit for ensuring that the ISL4238E/4XE powers up as soon as FORCEOFF switches high. The rising edge of the Master Powerdown signal forces the device to power up, and the ISL4238E/4XE returns to enhanced automatic powerdown mode an RC time constant after this rising edge. The time constant isn't critical, because the ISL4238E/4XE remains powered up for 30 seconds after the FORCEON falling edge, even if there are no signal transitions. This gives slow-towake systems (e.g., a mouse) plenty of time to start transmitting, and as long as it starts transmitting within 30 seconds both systems remain enabled.

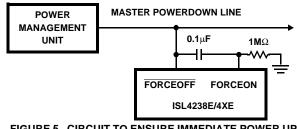
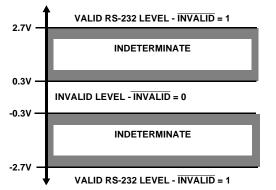


FIGURE 5. CIRCUIT TO ENSURE IMMEDIATE POWER UP WHEN EXITING FORCED POWERDOWN

## INVALID Output

The INVALID output always indicates (see Table 2) whether or not 30µs have elapsed with invalid RS-232 signals (see Figures 6 and 9) persisting on all of the receiver inputs, giving the user an easy way to determine when the interface block should power down. Invalid receiver levels occur whenever the driving peripheral's outputs are shut off (powered down) or when the RS-232 interface cable is disconnected. In the case of a disconnected interface cable where all the receiver inputs are floating (but pulled to GND by the internal receiver pull down resistors), the INVALID logic detects the invalid levels and drives the output low. The power management logic then uses this indicator to power down the interface block. Reconnecting the cable restores valid levels at the receiver inputs, INVALID switches high, and the power management logic wakes up the interface block. INVALID can also be used to indicate the DTR or RING INDICATOR signal, as long as the other receiver inputs are floating, or driven to GND (as in the case of a powered down driver).

INVALID switches high 1µs after detecting a valid RS-232 level on a receiver input. INVALID operates in all modes (forced or automatic powerdown, or forced on), so it is also useful for systems employing manual powerdown circuitry.



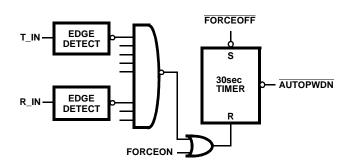
#### FIGURE 6. DEFINITION OF VALID RS-232 RECEIVER LEVELS Enhanced Automatic Powerdown

Even greater power savings is available by using these devices which feature an *enhanced automatic* powerdown function. When the enhanced powerdown logic determines that no transitions have occurred on any of the transmitter nor receiver inputs for 30 seconds, the charge pump and transmitters powerdown, thereby reducing supply current to 10nA. The ISL4238E/4XE automatically powers back up whenever it detects a transition on one of these inputs. This automatic powerdown feature provides additional system power savings without changes to the existing operating system.

Enhanced automatic powerdown operates when the FORCEON input is low, and the FORCEOFF input is high. Tying FORCEON high disables automatic powerdown, but manual powerdown is always available via the overriding FORCEOFF input. Table 2 summarizes the enhanced automatic powerdown functionality.

Figure 7 illustrates the enhanced powerdown control logic. Note that once the ISL4238E/4XE enters powerdown (manually or automatically), the 30 second timer remains timed out (set), keeping the ISL4238E/4XE powered down until FORCEON transitions high, or until a transition occurs on a receiver or transmitter input.

The INVALID output signal switches low to indicate that invalid levels have persisted on all of the receiver inputs for more than  $30\mu s$  (see Figure 9), but this has no direct effect



#### FIGURE 7. ENHANCED AUTOMATIC POWERDOWN LOGIC

on the state of the ISL4238E/4XE (see the next sections for methods of utilizing INVALID to power down the device).

The time to recover from automatic powerdown mode is typically  $100\mu s$ .

#### Emulating Standard Automatic Powerdown

If enhanced automatic powerdown isn't desired, the user can implement the standard automatic powerdown feature (mimics the function on the ISL4243E) by connecting the INVALID output to the FORCEON and FORCEOFF inputs, as shown in Figure 8. After 30us of invalid receiver levels, INVALID switches low and drives the ISL4238E/4XE into a forced powerdown condition. INVALID switches high as soon as a receiver input senses a valid RS-232 level, forcing the ISL4238E/4XE to power on. See the "INVALID DRIVING FORCEON AND FORCEOFF" section of Table 2 for an operational summary. This operational mode is perfect for handheld devices that communicate with another computer via a detachable cable. Detaching the cable allows the internal receiver pull-down resistors to pull the inputs to GND (an invalid RS-232 level), causing the 30us timer to time-out and drive the IC into powerdown. Reconnecting the cable restores valid levels, causing the IC to power back up.

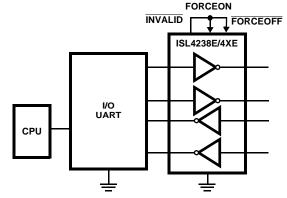


FIGURE 8. CONNECTIONS FOR AUTOMATIC POWERDOWN WHEN NO VALID RECEIVER SIGNALS ARE PRESENT

#### Hybrid Automatic Powerdown Options

For devices which communicate only through a detachable cable, connecting  $\overline{\text{INVALID}}$  to  $\overline{\text{FORCEOFF}}$  (with  $\overline{\text{FORCEON}} = 0$ ) may be a desirable configuration. While the

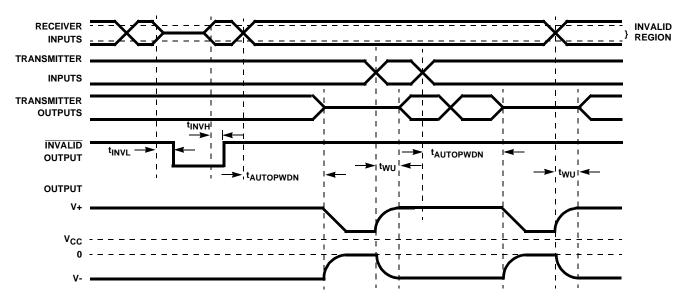


FIGURE 9. ENHANCED AUTOMATIC POWERDOWN AND INVALID TIMING DIAGRAMS

cable is attached INVALID and FORCEOFF remain high, so the enhanced automatic powerdown logic powers down the RS-232 device whenever there is 30 seconds of inactivity on the receiver and transmitter inputs. Detaching the cable allows the receiver inputs to drop to an invalid level (GND), so INVALID switches low and forces the RS-232 device to power down. The ISL4238E/4XE remains powered down until the cable is reconnected (INVALID = FORCEOFF = 1) and a transition occurs on a receiver or transmitter input (see Figure 7). For immediate power up when the cable is reattached, connect FORCEON to FORCEOFF through a network similar to that shown in Figure 5.

## **Capacitor Selection**

The ISL4238E charge pumps require  $0.1\mu$ F, or greater, capacitors for 3.3V (5% tolerance) operation. For other supply voltages refer to Table 3 for capacitor values. Do not use values smaller than those listed in Table 3.

V <sub>CC</sub> (V)	C <sub>1</sub> (μF)	C <sub>2</sub> , C <sub>3</sub> , C <sub>4</sub> (μF)
3.0 to 3.6 (3.3V ±10%)	0.22	0.22
3.15 to 3.6 (3.3V ±5%)	0.1	0.1
4.5 to 5.5	0.047	0.33
3.0 to 5.5	0.22	1

TABLE 3.	REQUIRED	CAPACITOR	VALUES	(ISL4238E)

The ISL4244E/45E charge pumps require  $0.1\mu$ F capacitors for proper operation. Increasing the capacitor values (by a factor of 2) reduces ripple on the transmitter outputs and slightly reduces power consumption. C<sub>2</sub>, C<sub>3</sub>, and C<sub>4</sub> can be increased without increasing C<sub>1</sub>'s value, however, do not increase C<sub>1</sub> without also increasing C<sub>2</sub>, C<sub>3</sub>, and C<sub>4</sub> to maintain the proper ratios (C<sub>1</sub> to the other capacitors). When using minimum required capacitor values, make sure that capacitor values do not degrade excessively with temperature. If in doubt, use capacitors with a larger nominal value. The capacitor's equivalent series resistance (ESR) usually rises at low temperatures and it influences the amount of ripple on V+ and V-.

## Power Supply Decoupling

In most circumstances a  $0.1\mu$ F bypass capacitor is adequate. In applications that are particularly sensitive to power supply noise, decouple V<sub>CC</sub> to ground with a capacitor of the same value as the charge-pump capacitor C<sub>1</sub>. Connect the bypass capacitor as close as possible to the IC.

# Transmitter Outputs when Exiting Powerdown

Figure 10 shows the response of two transmitter outputs when exiting powerdown mode. As they activate, the two transmitter outputs properly go to opposite RS-232 levels, with no glitching, ringing, nor undesirable transients. Each transmitter is loaded with  $3k\Omega$  in parallel with 2500pF. Note that the transmitters enable only when the magnitude of the supplies exceed approximately 3V.

## **Operation Down to 2.7V**

ISL4238E/4XE transmitter outputs meet RS-562 levels ( $\pm$ 3.7V), at the full data rate, with V<sub>CC</sub> as low as 2.7V. RS-562 levels typically ensure interoperability with RS-232 devices.

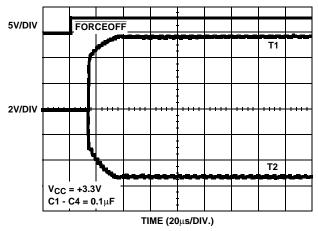
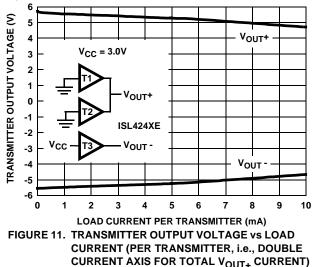


FIGURE 10. TRANSMITTER OUTPUTS WHEN EXITING POWERDOWN

## Mouse Driveability

The ISL424XE are specifically designed to power a serial mouse while operating from low voltage supplies. Figure 11 shows the transmitter output voltages under increasing load current. The on-chip switching regulator ensures the transmitters will supply at least  $\pm$ 5V during worst case conditions (15mA for paralleled V+ transmitters, 7.3mA for single V- transmitter).



## High Data Rates

The ISL4238E/4XE maintain the RS-232 ±5V minimum transmitter output voltages even at high data rates. Figure 12 details a transmitter loopback test circuit, and Figure 13 illustrates the ISL4238E/44E loopback test result at 120kbps. For this test, all transmitters were simultaneously driving RS-232 loads in parallel with 1000pF, at 120kbps. Figure 14 shows the ISL4238E/44E loopback results for a single transmitter driving 1000pF and an RS-232 load at 250kbps. Figure 15 illustrates the ISL4245E loopback test result at 250kbps. For this test, all transmitters were simultaneously driving RS-232 loads in parallel with 1000pF, at 250kbps. For this test, all transmitters were simultaneously driving RS-232 loads in parallel with 1000pF, at 250kbps. Figure 16 shows the ISL4245E loopback results

for a single transmitter driving 250pF and an RS-232 load at 1Mbps. The static transmitters were also loaded with an RS-232 receiver.

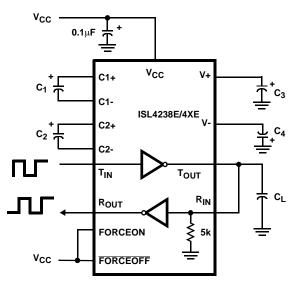


FIGURE 12. TRANSMITTER LOOPBACK TEST CIRCUIT

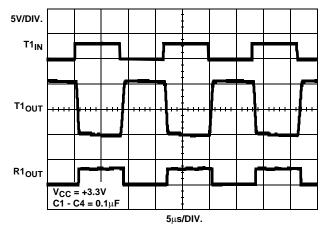
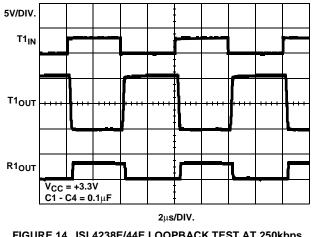
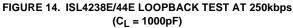


FIGURE 13. ISL4238E/44E LOOPBACK TEST AT 120kbps





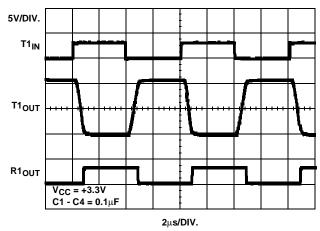
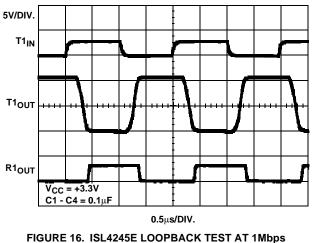


FIGURE 15. ISL4245E LOOPBACK TEST AT 250kbps



 $(C_{L} = 250 pF)$ 

## Interconnection with 3V and 5V Logic

The ISL4238E/4XE directly interface with 5V CMOS and TTL logic families. Nevertheless, with the ISL4238E/4XE at 3.3V, and the logic supply at 5V, AC, HC, and CD4000 outputs can drive ISL4238E/4XE inputs, but ISL4238E/4XE outputs do not reach the minimum V<sub>IH</sub> for these logic families. See Table 4 for more information.

## TABLE 4. LOGIC FAMILY COMPATIBILITY WITH VARIOUS SUPPLY VOLTAGES

SYSTEM POWER-SUPPLY VOLTAGE (V)	V <sub>CC</sub> SUPPLY VOLTAGE (V)	COMPATIBILITY			
3.3	3.3	Compatible with all CMOS families.			
5	5	Compatible with all TTL and CMOS logic families.			
5	3.3	Compatible with ACT and HCT CMOS, and with TTL. ISL4238E/4XE outputs are incompatible with AC, HC, and CD4000 CMOS inputs.			

## ±15kV ESD Protection

All pins on ISL4238E/4XE devices include ESD protection structures, but the RS-232 pins (transmitter outputs and receiver inputs) incorporate advanced structures which allow them to survive ESD events up to  $\pm$ 15kV. The RS-232 pins are particularly vulnerable to ESD damage because they typically connect to an exposed port on the exterior of the finished product. Simply touching the port pins, or connecting a cable, can cause an ESD event that might destroy unprotected ICs. These new ESD structures protect the device whether or not it is powered up, protect without allowing any latchup mechanism to activate, and don't interfere with RS-232 signals as large as  $\pm$ 25V.

## Human Body Model (HBM) Testing

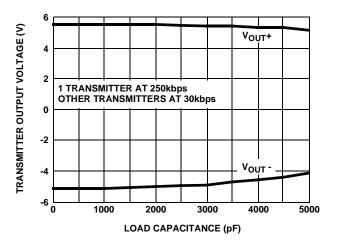
As the name implies, this test method emulates the ESD event delivered to an IC during human handling. The tester delivers the charge through a  $1.5k\Omega$  current limiting resistor, making the test less severe than the IEC6100 test which utilizes a  $330\Omega$  limiting resistor. The HBM method determines an ICs ability to withstand the ESD transients typically present during handling and manufacturing. Due to the random nature of these events, each pin is tested with respect to all other pins. The RS-232 pins on "E" family devices can withstand HBM ESD events to  $\pm 15kV$ .

#### IEC6100-4-2 Testing

The IEC6100 test method applies to finished equipment, rather than to an individual IC. Therefore, the pins most likely to suffer an ESD event are those that are exposed to the outside world (the RS-232 pins in this case), and the IC is tested in its typical application configuration (power applied) rather than testing each pin-to-pin combination. The lower current limiting resistor coupled with the larger charge storage capacitor yields a test that is much more severe than the HBM test. The extra ESD protection built into this device's RS-232 pins allows the design of equipment meeting level 4 criteria without the need for additional board level protection on the RS-232 port.

#### **AIR-GAP DISCHARGE TEST METHOD**

For this test method, a charged probe tip moves toward the IC pin until the voltage arcs to it. The current waveform delivered to the IC pin depends on approach speed, humidity, temperature, etc., so it is difficult to obtain repeatable results. The "E" device RS-232 pins withstand  $\pm$ 15kV air-gap discharges.



## Typical Performance Curves V<sub>CC</sub> = 3.3V, T<sub>A</sub> = 25°C

FIGURE 17. ISL4238E TRANSMITTER OUTPUT VOLTAGE vs LOAD CAPACITANCE

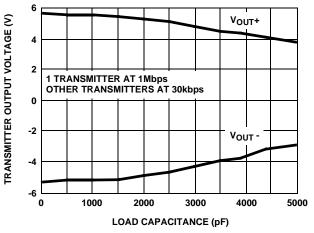


FIGURE 19. ISL4245E TRANSMITTER OUTPUT VOLTAGE vs LOAD CAPACITANCE

#### CONTACT DISCHARGE TEST METHOD

During the contact discharge test, the probe contacts the tested pin before the probe tip is energized, thereby eliminating the variables associated with the air-gap discharge. The result is a more repeatable and predictable test, but equipment limits prevent testing devices at voltages higher than  $\pm 8$ kV. All "E" family devices survive  $\pm 8$ kV contact discharges on the RS-232 pins.

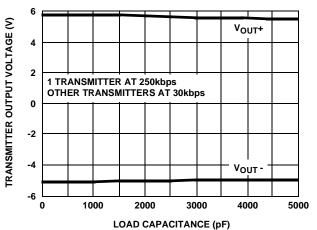


FIGURE 18. ISL4244E TRANSMITTER OUTPUT VOLTAGE vs LOAD CAPACITANCE

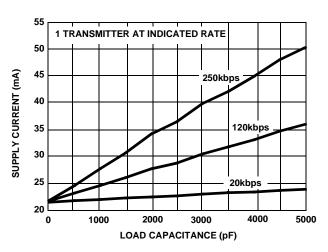
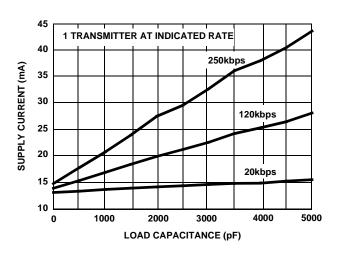


FIGURE 20. ISL4238E SUPPLY CURRENT vs LOAD CAPACITANCE WHEN TRANSMITTING DATA

## **Typical Performance Curves** $V_{CC} = 3.3V$ , $T_A = 25^{\circ}C$ (Continued)





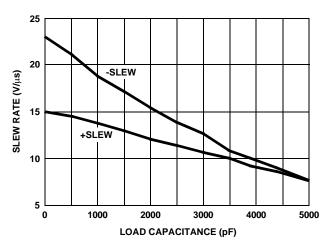


FIGURE 23. ISL4238E/44E SLEW RATE vs LOAD CAPACITANCE

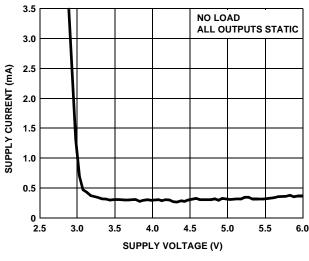


FIGURE 25. SUPPLY CURRENT vs SUPPLY VOLTAGE

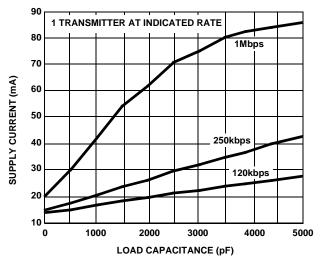


FIGURE 22. ISL4245E SUPPLY CURRENT vs LOAD CAPACITANCE WHEN TRANSMITTING DATA

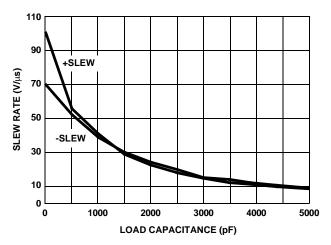


FIGURE 24. ISL4245E SLEW RATE vs LOAD CAPACITANCE

## **Die Characteristics**

SUBSTRATE POTENTIAL (POWERED UP)

GND

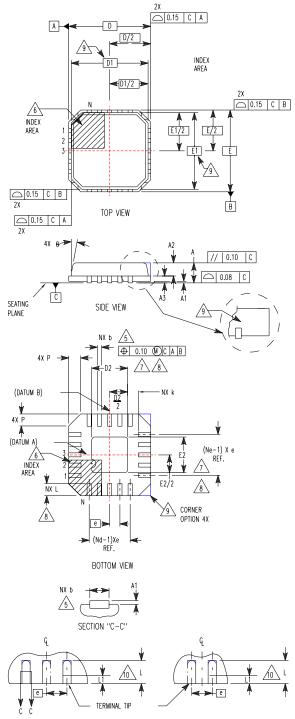
TRANSISTOR COUNT

ISL4238E: 1235 ISL4244E: 1109 ISL4245E: 1109

#### PROCESS

Si Gate CMOS

## Quad Flat No-Lead Plastic Package (QFN) Micro Lead Frame Plastic Package (MLFP)



FOR ODD TERMINAL/SIDE

FOR EVEN TERMINAL/SIDE

#### L32.5x5

#### 32 LEAD QUAD FLAT NO-LEAD PLASTIC PACKAGE (COMPLIANT TO JEDEC MO-220VHHD-2 ISSUE C

(COMPLIANT	IO JEDEC	WO-220VHHD-2	1330E C	
SYMBOL	MIN	NOMINAL	MAX	NOTES
А	0.80	0.90	1.00	-
A1	-	-	0.05	-
A2	-	-	1.00	9
A3		0.20 REF		9
b	0.18	0.23	0.30	5,8
D		5.00 BSC		-
D1		4.75 BSC		9
D2	2.95	3.10	3.25	7,8
E	5.00 BSC			-
E1	4.75 BSC			9
E2	2.95 3.10 3.25			7,8
е		0.50 BSC		-
k	0.25	-	-	-
L	0.30	0.40	0.50	8
L1	-	-	0.15	10
Ν	32			2
Nd	8			3
Ne	8 8			3
Р	0.60			9
θ	-	-	12	9
			F	Rev. 1 10/02

#### NOTES:

- 1. Dimensioning and tolerancing conform to ASME Y14.5-1994.
- 2. N is the number of terminals.
- 3. Nd and Ne refer to the number of terminals on each D and E.
- 4. All dimensions are in millimeters. Angles are in degrees.
- 5. Dimension b applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
- 6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.
- 7. Dimensions D2 and E2 are for the exposed pads which provide improved electrical and thermal performance.
- 8. Nominal dimensions are provided to assist with PCB Land Pattern Design efforts, see Intersil Technical Brief TB389.
- Features and dimensions A2, A3, D1, E1, P & 0 are present when Anvil singulation method is used and not present for saw singulation.
- Depending on the method of lead termination at the edge of the package, a maximum 0.15mm pull back (L1) maybe present. L minus L1 to be equal to or greater than 0.3mm.

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